

Siemens
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SIMATIC IPC547J (rack PC, 19", 4 U); interfaces: 2x USB 3.0 on the front; COM1, audio on the rear side; 7 slots: 5x PCI Express, 2x PCI, temperature and fan monitoring; watchdog; card retainer Core i9-10900E (10C/20T, 2.8 (4.7) GHz, 20 MB cache), mainboard (chipset W480E, 3x Gbit Ethernet, 1x DVI-D, 2x DisplayPort, 6x USB 3.1 Gen.2, 2x USB 2.0 internal, AMT), 960 GB SSD 2.5 SATA, enclosure with drive support type A (for rack units on the front), blue chromated, 100/240 V AC industrial power supply unit, power supply cable China, 64 GB DDR4 SDRAM (2x 32 GB), dual channel, PCIe x16 graphics card NVIDIA Quadro P2200 (4x DP: without adapter) (1 slot occupied), Windows 10 IoT Enterprise 2019 LTSC MUI (en/de/fr/it/es), 64 bit for Core i7/i9/Xeon, SIMATIC IPC DiagMonitor and Image & Partition Creator enclosed,

General information	
Product type designation	IPC547J
Installation type/mounting	
Mounting	For horizontal and vertical installation; prepared for telescopic rails; 19" mounting bracket can be removed externally; tower kit (optional)
Design	Rack PC, 19", 4U
Supply voltage	
Type of supply voltage	100/240 V AC (autorange) 50 / 60 Hz; optional redundant 100/240 V AC
Line frequency	
• Rated value 50 Hz	Yes
• Rated value 60 Hz	Yes
Mains buffering	
• Mains/voltage failure stored energy time	20 ms
Processor	
Processor type	Intel Xeon W-1270E (8C/16T, 3.4 (4.8) GHz, 16 MB Cache); Intel Core i9-10900E (10C/20T, 2.8 (4.7) GHz, 20 MB Cache); Intel Core i7-10700E (8C/16T, 2.9 (4.5) GHz, 16 MB Cache); Intel Core i5-10500E (6C/12T, 3.1 (4.2) GHz, 12 MB Cache); Intel Core i3-10100E (4C/8T, 3.2 (3.8) GHz, 6 MB Cache)
Chipset	Intel W480E / Intel H410
Graphic	
Graphics controller	Intel® UHD Graphics 630
Graphics card	Yes; NVIDIA T400, Quadro RTX P2200, Quadro RTX 4000
Drives	
Hard disk	1 TB HDD 3.5" SATA, 2x 1 TB HDD 3.5" SATA, 1 TB HDD 3.5" SATA + 960 GB SSD 2.5" SATA, RAID1, 2x 1 TB HDD 3.5" SATA, RAID1, 2x 1 TB HDD [Enterprise] 3.5" SATA, RAID1, 2x 2 TB HDD [Enterprise] 3.5" SATA, RAID1, 2x 2 TB HDD [Enterprise] 3.5" SATA + 2 TB HDD [Enterprise] 3.5" SATA as hot spare, RAID1, 2x 2 TB HDD [Enterprise] 3.5" SATA + 960 GB SSD 2.5" SATA, RAID5, 3x 2 TB HDD [Enterprise] 3.5" SATA, RAID5, 3x 2 TB HDD [Enterprise] 3.5" SATA + 2 TB HDD [Enterprise] 3.5" SATA as hot spare
SSD	Yes; 480 GB 2.5" SATA SSD, 1x 960 GB 2.5" SATA SSD, 2x 480 GB 2.5" SATA SSD, RAID1 2x 480 GB 2.5" SATA SSD, RAID1 2x 960 GB 2.5" SATA SSD; 1x 512 GB M.2 NVMe SSD, 1x 1 024 GB M.2 NVMe SSD
Slot for drives	Mounting internally in vibration/shock-absorbing drive cage Type B or mounting on the front in removable trays (hot swap in RAID configurations) in drive cage Type A; mounting internally on the fixed drive cage optional
Storage	
Main memory	4 GB to 128 GB DDR4 2933 SDRAM DIMM
Capacity of main memory, max.	128 Gbyte
Hardware configuration	
Slots	
• Number of PCI slots	2
• Number of PCI slots	5
Interfaces	
Interfaces/bus type	mainboard (H410 chip set): 2x Intel Gigabit Ethernet (RJ45, teaming-capable), USB 3.1 Gen 1: 2x on rear, 2x on front, USB 2.0: 4x on rear, 1x internal e.g. for software dongle with optional interlock, 1x DisplayPort V1.2, 1x DVI-D, 1x

	COM1, audio: line in, line out, micro; mainboard (W480E chip set): 3x Intel Gigabit Ethernet (RJ45, teaming-capable), USB 3.1 Gen 2: 4x type A, 2x type C, on rear, USB 3.1 Gen 1: 2x on front, USB 2.0: 2x internal e.g. for software dongle with optional interlock, 2x DisplayPort V1.2, 1x DVI-D, 1x COM1, audio: line in, line out, micro
serial interface	COM1: 1x RS 232 or RS 485; COM2 (optional) 1x RS 232
Video interfaces	
• Graphics interface	2x DisplayPort and 1x DVI-D onboard; 1x VGA via DP-VGA adapter cable (optional); graphics card PCIe (x16), Triple Head (3x mini DisplayPort, 2 GB graphics memory, 3x mini DisplayPort to DisplayPort adapter cable) (optional)
Industrial Ethernet	
• Industrial Ethernet interface	
— 100 Mbps	Yes
— 1000 Mbps	Yes
Interrupts/diagnostics/status information	
LED status display	POWER, HDD, ETHERNET 1, ETHERNET 2, ETHERNET 3, WATCHDOG, TEMP, FAN, HDD3 ALARM, HDD2 ALARM, HDD1 ALARM, HDD0 ALARM
Integrated Functions	
Monitoring functions	
• Temperature monitoring	Yes
• Fan	Yes
• Monitoring function via network	Optional
Degree and class of protection	
IP (at the front)	IP30
IP (rear)	IP20
Standards, approvals, certificates	
Siemens Eco Profile (SEP)	Siemens EcoTech
CE mark	Yes; For use in industrial areas as well as domestic, business and commercial environments (emitted interference: EN 61000-6-3:2007 +A1:2011, noise immunity: EN 61000-6-2:2005)
CSA approval	Yes; CAN/CSA-C22.2 No. 61010-2-201 Second Edition
UL approval	UL 61010-2-201 Second Edition, File E85972
cULus	Yes; UL 61010-2-201 Second Edition; CAN/CSA-C22.2 No. 61010-2-201 Second Edition
RCM (formerly C-TICK)	Yes
KC approval	Yes
EAC (formerly Gost-R)	Yes
Dust protection	With front door closed: G2 EN 779, 99% of particles > 0.5 mm are filtered
Ecological footprint	
• environmental product declaration	Yes
Global warming potential	
— global warming potential, (total) [CO2 eq]	1 910 kg
— global warming potential, (during production) [CO2 eq]	225 kg
— global warming potential, (during operation) [CO2 eq]	1 740 kg
— global warming potential, (after end of life cycle) [CO2 eq]	-55.5 kg
Ambient conditions	
Ambient temperature during operation	
• min.	0 °C; Max. 10 °C/h (no condensation)
• max.	40 °C
Ambient temperature during storage/transportation	
• min.	-20 °C
• max.	60 °C
Vibrations	
• Vibration resistance during operation acc. to IEC 60068-2-6	Tested according to IEC 60068-2-6, 10 cycles; 20 to 58 Hz: 0.015 mm; 58 to 200 Hz: 2 m/s² (0.2 g)
Operating systems	
pre-installed operating system	Windows 10 IoT Enterprise 2021 LTSC, Windows 10 IoT Enterprise 2019 LTSC; Windows Server 2022 Standard Edition incl. 5 clients; Windows Server 2019 Standard Edition incl. 5 clients
without operating system	Yes

Dimensions	
Width	430 mm
Height	177 mm; 4U
Depth	446 mm; Device with short enclosure: 356 mm

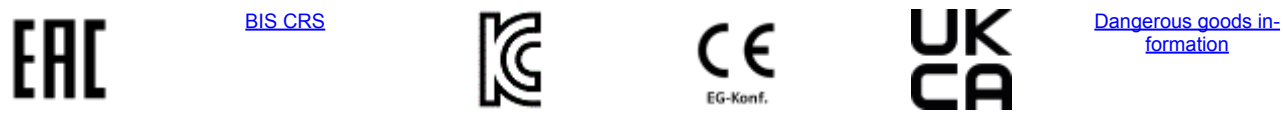
Approvals / Certificates

General Product Approval



General Product Approval

Dangerous goods



Dangerous goods

Environment



last modified:

5/22/2026